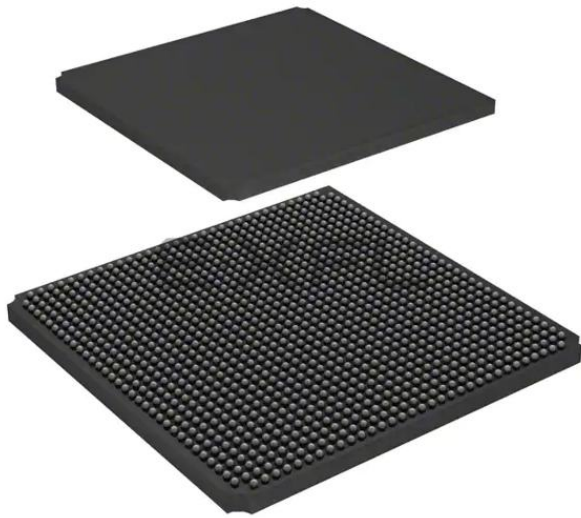




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

Details

Product Status	Obsolete
Number of LABs/CLBs	8375
Number of Logic Elements/Cells	67000
Total RAM Bits	4642816
Number of I/O	436
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1152-BBGA
Supplier Device Package	1152-FPBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2m70se-5f1152c

one clock is selected for each input register, pipeline register and output register. Similarly Clock enable (CE) and Reset (RST) are selected from their four respective sources (CE0, CE1, CE2, CE3 and RST0, RST1, RST2, RST3) at each input register, pipeline register and output register.

Signed and Unsigned with Different Widths

The DSP block supports different widths of signed and unsigned multipliers besides x9, x18 and x36 widths. For unsigned operands, unused upper data bits should be filled to create a valid x9, x18 or x36 operand. For signed two's complement operands, sign extension of the most significant bit should be performed until x9, x18 or x36 width is reached. Table 2-8 provides an example of this.

Table 2-8. Sign Extension Example

Number	Unsigned	Unsigned 9-bit	Unsigned 18-bit	Signed	Two's Complement Signed 9 Bits	Two's Complement Signed 18 Bits
+5	0101	000000101	0000000000000000101	0101	000000101	0000000000000000101
-6	N/A	N/A	N/A	1010	111111010	1111111111111111010

OVERFLOW Flag from MAC

The sysDSP block provides an overflow output to indicate that the accumulator has overflowed. When two unsigned numbers are added and the result is a smaller number than the accumulator, “roll-over” is said to have occurred and an overflow signal is indicated. When two positive numbers are added with a negative sum and when two negative numbers are added with a positive sum, then the accumulator “roll-over” is said to have occurred and an overflow signal is indicated. Note that when overflow occurs the overflow flag is present for only one cycle. By counting these overflow pulses in FPGA logic, larger accumulators can be constructed. The conditions overflow signals for signed and unsigned operands are listed in Figure 2-27.

Figure 2-27. Accumulator Overflow/Underflow

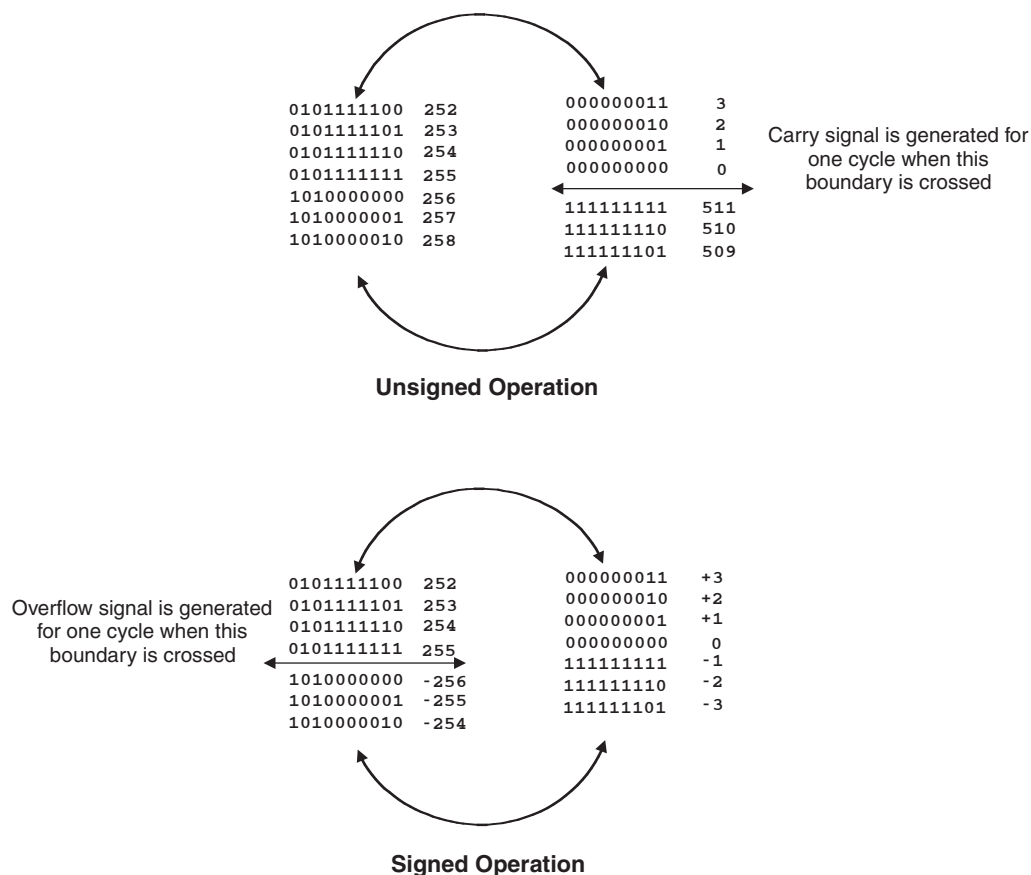
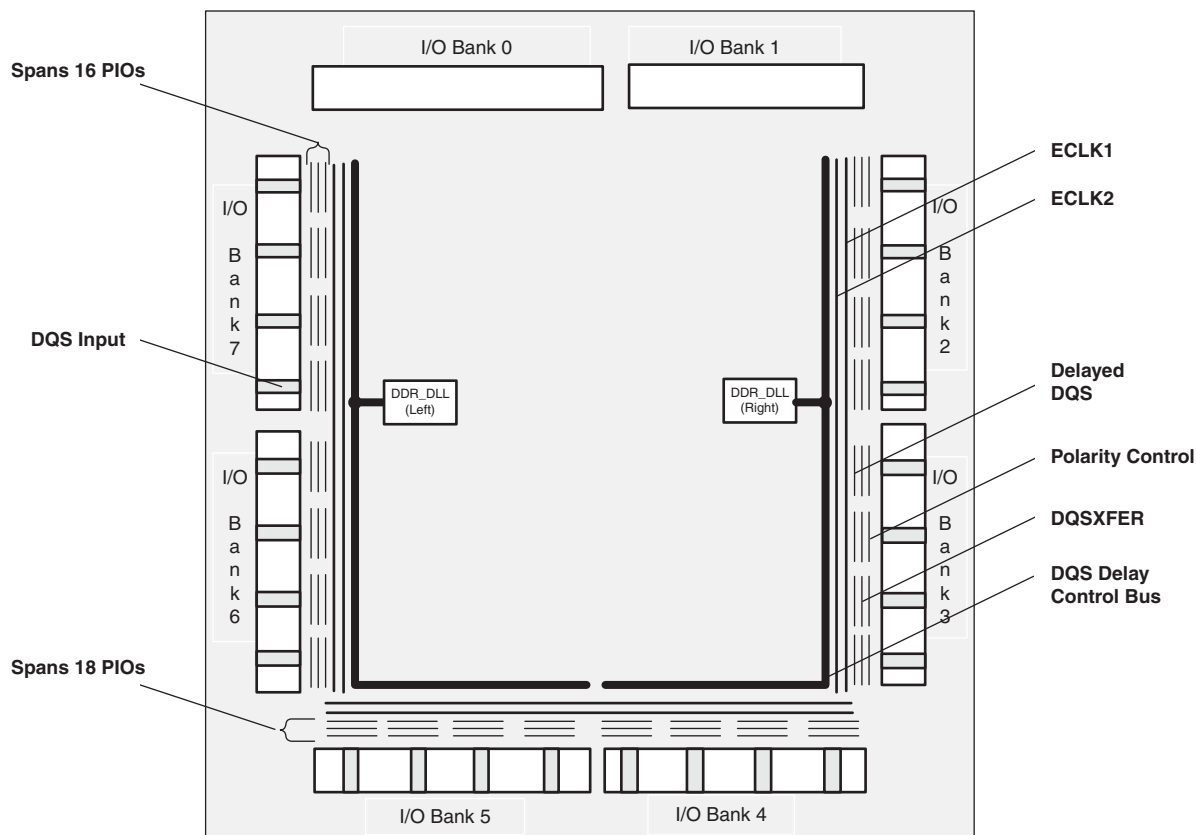
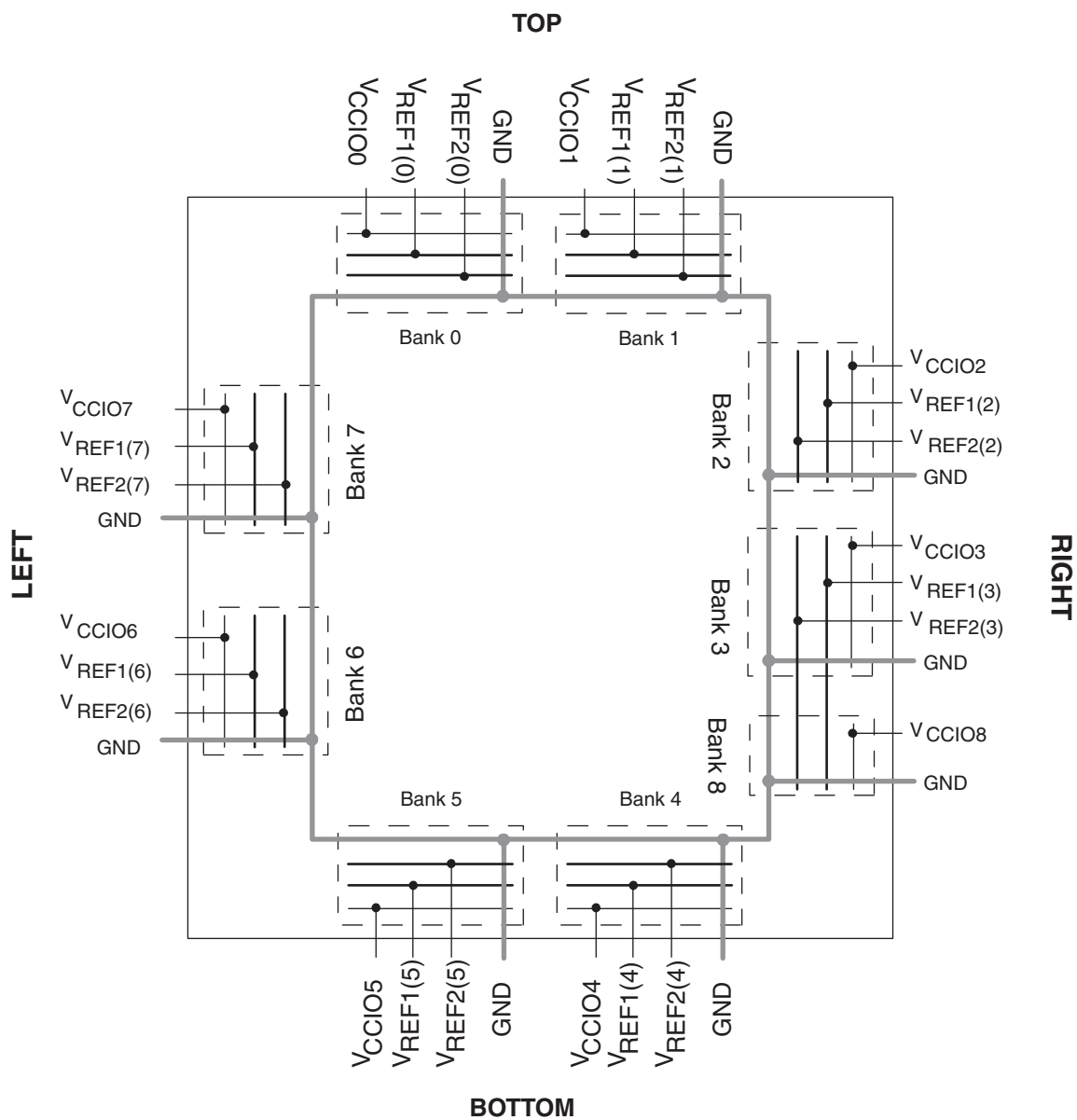


Figure 2-35. Edge Clock, DLL Calibration and DQS Local Bus Distribution



Note: Bank 8 is not shown.

Figure 2-37. LatticeECP2 Banks



for checking soft errors (SED) in SRAM. SED can be run on a programmed device when the user logic is not active. If a soft error occurs, during user mode (normal operation) the device can be programmed to either reload from a known good boot image or generate an error signal.

For further information about Soft Error Detect (SED) support, please see the list of additional technical documentation at the end of this data sheet.

External Resistor

LatticeECP2/M devices require a single external, 10K ohm $\pm 1\%$ value between the XRES pin and ground. Device configuration will not be completed if this resistor is missing. There is no boundary scan register on the external resistor pad.

On-Chip Oscillator

Every LatticeECP2/M device has an internal CMOS oscillator which is used to derive a Master Clock for configuration. The oscillator and the Master Clock run continuously and are available to user logic after configuration is completed. The software default value of the Master Clock is 2.5MHz. Table 2-16 lists all the available Master Configuration Clock frequencies for normal non-encrypted mode and encrypted mode. When a different Master Clock is selected during the design process, the following sequence takes place:

1. Device powers up with a Master Clock frequency of 3.1MHz.
2. During configuration, users select a different master clock frequency.
3. The Master Clock frequency changes to the selected frequency once the clock configuration bits are received.
4. If the user does not select a master clock frequency, then the configuration bitstream defaults to the Master Clock frequency of 2.5MHz.

This internal CMOS oscillator is available to the user by routing it as an input clock to the clock tree. For further information about the use of this oscillator for configuration or user mode, please see the list of additional technical documentation at the end of this data sheet.

Table 2-16. Selectable Master Clock (CCLK) Frequencies During Configuration

Non-Encrypted Mode CCLK (MHz)			Encrypted Mode CCLK (MHz)
2.5 ¹	13.0	45.0	2.5 ¹
4.3	15.0	55.0	5.4
5.4	20.0	60.0	10.0
6.9	26.0	—	—
8.1	30.0	—	—
9.2	34.0	—	—
10.0	41.0	130.0	—

1. Software default frequency.

Density Shifting

The LatticeECP2/M family is designed to ensure that different density devices in the same family and in the same package have the same pinout. Furthermore, the architecture ensures a high success rate when performing design migration from lower density devices to higher density devices. In many cases, it is also possible to shift a lower utilization design targeted for a high-density device to a lower density device. However, the exact details of the final resource utilization will impact the likelihood of success in each case. Design migration between LatticeECP2 and LatticeECP2M families is not possible. For specific requirements relating to sysCONFIG pins of the ECP2M50, M70 and M100, see the Logic Signal Connections tables.

LatticeECP2/M External Switching Characteristics⁹ (Continued)

Over Recommended Operating Conditions

Parameter	Description	Device	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t _{DIBSPI}	Data Invalid Before Clock (Transmit)	ECP2-20	—	280	—	280	—	280	ps
		ECP2-35	—	280	—	280	—	280	ps
		ECP2-50	—	280	—	280	—	280	ps
		ECP2-70	—	280	—	280	—	280	ps
		ECP2M20	—	230	—	230	—	230	ps
		ECP2M35	—	230	—	230	—	230	ps
		ECP2M50	—	230	—	230	—	230	ps
		ECP2M70	—	230	—	230	—	230	ps
		ECP2M100	—	230	—	230	—	230	ps
XGMII I/O Pin Parameters (312 Mbps) ⁵									
t _{SUXGMII}	Data Setup Before Read Clock	ECP2/M	480	—	480	—	480	—	ps
t _{HXGMII}	Data Hold After Read Clock	ECP2/M	480	—	480	—	480	—	ps
t _{DVBCKXGMII}	Data Valid Before Clock	ECP2/M	960	—	960	—	960	—	ps
t _{DVACKXGMII}	Data Valid After Clock	ECP2/M	960	—	960	—	960	—	ps
Primary									
f _{MAX_PRI} ⁷	Frequency for Primary Clock Tree	ECP2/M	—	420	—	357	—	311	MHz
t _{W_PRI}	Clock Pulse Width for Primary Clock	ECP2/M	0.95	—	1.19	—	2.00	—	ns
t _{SKEW_PRI}	Primary Clock Skew Within a Bank	ECP2/M	—	300	—	360	—	420	ps
Edge Clock									
f _{MAX_EDGE} ⁷	Frequency for Edge Clock	ECP2/M	—	420	—	357	—	311	MHz
t _{W_EDGE}	Clock Pulse Width for Edge Clock	ECP2/M	0.95	—	1.19	—	2.00	—	ns
t _{SKEW_EDGE}	Edge Clock Skew Within an Edge of the Device	ECP2/M	—	300	—	360	—	420	ps

- General timing numbers based on LVCMOS 2.5, 12mA, 0pf load.
- DDR timing numbers based on SSTL25 for BGA packages only.
- DDR2 timing numbers based on SSTL18 for BGA packages only.
- SPI4.2 and SFI4 timing numbers based on LVDS25 for BGA packages only.
- XGMII timing numbers based on HSTL class I. A corresponding left/right dedicated clock buffer is used when using the SPI4.2 interface to the left or right edge of the device. For SPI4.2 mode, the software tool will help in selecting the appropriate clock buffer.
- IP will be used to support DDR and DDR2 memory data rates down to 95MHz. This approach uses a free-running clock and PFU register to sample the data instead of the hardwired DDR memory interface.
- Using the LVDS I/O standard.
- ECP2-6 and ECP2-12 do not support SPI4.2
- The AC numbers do not apply to PCLK6 and PCLK7.
- Applies to CLKOP only.
- Please refer to TN1159, [LatticeECP2/M Pin Assignment Recommendations](#) for best performance.

LatticeECP2 Power Supply and NC

Signals	144 TQFP ³	208 PQFP ³	256 fpBGA ⁴	484 fpBGA ⁴
VCC	16, 22, 29, 48, 54, 83, 94, 102, 128, 135	12, 19, 28, 40, 74, 80, 97, 116, 129, 140, 146, 171, 188, 198	LFE2-6: G7, G9, G10, H7, J10, K10, K8 LFE2-12/LFE2-20: G7, G9, G10, H7, J10, K10, K8	LFE2-12/LFE2-20: N6, N18, J10, J11, J12, J13, K14, K9, L14, L9, M14, M9, N14, N9, P10, P11, P12, P13 LFE2-35/LFE2-50: J10, J11, J12, J13, K14, K9, L14, L9, M14, M9, N14, N9, P10, P11, P12, P13
VCCIO0	139	195, 206	C5, E7	G10, G9, H8, H9
VCCIO1	117	162, 170	C12, E10	G11, G12, G13, G14
VCCIO2	106	143, 148	E14, G12	H14, H15, J15, K16
VCCIO3	89	123, 135	K12, M14	L16, M16, N16, P16
VCCIO4	64	93, 100	M10, P12	R14, T12, T13, T14
VCCIO5	42	55, 63	M7, P5	R9, T10, T11, T9
VCCIO6	31	38, 44	K5, M3	N7, P7, P8, R8
VCCIO7	9	10, 14	E3, G5	J8, K7, L7, M7
VCCIO8	85	113, 118	T15	P15, R15
VCCJ	35	51	K7	T8
VCCAUX	6, 39, 90, 142	7, 30, 70, 86, 125, 151, 174, 190	G8, H10, J7, K9	G5, K5, R5, V7, V11, V8, V13, V15, M17, P17, E17, G18, D11, F13, C5, E6
VCCPLL	None	None	None	LFE2-12/LFE2-20: None LFE2-35: N6, N18 LFE2-50: N6, N18, K6, J16
GND ¹	11, 21, 30, 47, 51, 61, 81, 95, 105, 120, 133, 138	5, 13, 17, 25, 32, 42, 60, 68, 77, 81, 89, 102, 115, 122, 139, 145, 159, 169, 175, 184, 192, 201	A1, A16, B12, B5, C8, E15, E2, H14, H8, H9, J3, J8, J9, M15, M2, P9, R12, R5, T1, T16	A22, AA19, AA4, AB1, AB22, B19, B4, C14, C9, D2, D21, F17, F6, H10, H11, H12, H13, J14, J20, J3, J9, K10, K11, K12, K13, K15, K8, L10, L11, L12, L13, L15, L8, M10, M11, M12, M13, M15, M8, N10, N11, N12, N13, N15, N8, P14, P20, P3, P9, R10, R11, R12, R13, U17, U6, W2, W21, Y14, Y9, A1
NC ²	LFE2-6: 45, 46, 124, 127 LFE2-12: 127	None	LFE2-6: K6, R3, P4 LFE2-12/LFE2-20: None	LFE2-12: E3, F3, F1, H4, F2, H5, G1, G3, G2, G4, K6, N1, M2, N2, M1, N3, N5, N4, P5, N19, M19, J22, L22, H22, K22, J16, D22, F21, E21, E22, H19, G20, G19, F20, C21, C22, H6, J6, H3, H2, H17, H16, H20, H18 LFE2-20/LFE2-35: K6, J16, H6, J6, H3, H2, H17, H16, H20, H18 LFE2-50: None

1. All grounds must be electrically connected at the board level. For fpBGA packages, the total number of GND balls is less than the actual number of GND logic connections from the die to the common package GND plane.
2. NC pins should not be connected to any active signals, VCC or GND.
3. Pin orientation follows the conventional order from the pin 1 marking of the top side view and counter-clockwise.
4. Pin orientation A1 starts from the upper left corner of the top side view with alphabetical order ascending vertically and numerical order ascending horizontally.

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-12E/12SE					LFE2-20E/20SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AA14	PB35B	4	BDQ33	C	PB44B	4	BDQ42	C
W13	PB37A	4	BDQ33	T	PB46A	4	BDQ42	T
GNDIO	GNDIO4	-			GNDIO4	-		
W14	PB37B	4	BDQ33	C	PB46B	4	BDQ42	C
AB18	PB39A	4	BDQ42	T	PB48A	4	BDQ51	T
AB19	PB39B	4	BDQ42	C	PB48B	4	BDQ51	C
Y15	PB41A	4	BDQ42	T	PB50A	4	BDQ51	T
V14	PB40A	4	BDQ42	T	PB49A	4	BDQ51	T
VCCIO	VCCIO4	4			VCCIO4	4		
AA15	PB41B	4	BDQ42	C	PB50B	4	BDQ51	C
W15	PB40B	4	BDQ42	C	PB49B	4	BDQ51	C
GNDIO	GNDIO4	-			GNDIO	-		
AB20	PB43A	4	BDQ42	T	PB52A	4	BDQ51	T
AA16	PB42A	4	BDQS42	T	PB51A	4	BDQS51	T
AB21	PB43B	4	BDQ42	C	PB52B	4	BDQ51	C
AA17	PB42B	4	BDQ42	C	PB51B	4	BDQ51	C
Y16	PB45A	4	BDQ42	T	PB54A	4	BDQ51	T
U15	PB44A	4	BDQ42	T	PB53A	4	BDQ51	T
VCCIO	VCCIO4	4			VCCIO4	4		
W16	PB45B	4	BDQ42	C	PB54B	4	BDQ51	C
U16	PB44B	4	BDQ42	C	PB53B	4	BDQ51	C
AA18	PB46A	4	BDQ42	T	PB55A	4	BDQ51	T
AA20	PB46B	4	BDQ42	C	PB55B	4	BDQ51	C
GNDIO	GNDIO4	-			GNDIO	-		
V16	PB49A	4	BDQ51	T	PB58A	4	BDQ60	T
V17	PB49B	4	BDQ51	C	PB58B	4	BDQ60	C
AA21	PB48A	4	BDQ51	T	PB57A	4	BDQ60	T
VCCIO	VCCIO4	4			VCCIO4	4		
Y19	PB51A	4	BDQS51	T	PB60A	4	BDQS60	T
AA22	PB48B	4	BDQ51	C	PB57B	4	BDQ60	C
Y20	PB51B	4	BDQ51	C	PB60B	4	BDQ60	C
Y18	PB50A	4	BDQ51	T	PB59A	4	BDQ60	T
GNDIO	GNDIO4	-			GNDIO4	-		
Y21	PB53A	4	BDQ51	T	PB62A	4	BDQ60	T
Y17	PB50B	4	BDQ51	C	PB59B	4	BDQ60	C
Y22	PB53B	4	BDQ51	C	PB62B	4	BDQ60	C
W17	PB52A	4	BDQ51	T	PB61A	4	BDQ60	T
VCCIO	VCCIO4	4			VCCIO4	4		
U18	PB54A	4	BDQ51	T	PB63A	4	BDQ60	T
W18	PB52B	4	BDQ51	C	PB61B	4	BDQ60	C
V18	PB54B	4	BDQ51	C	PB63B	4	BDQ60	C
GNDIO	GNDIO4	-			GNDIO4	-		
T15	PB55A	4	VREF2_4/BDQ51	T	PB64A	4	VREF2_4/BDQ60	T
T16	PB55B	4	VREF1_4/BDQ51	C	PB64B	4	VREF1_4/BDQ60	C

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
U24	PR30B	3	RLM0_GPLL_C_IN_A**/RDQ34	C (LVDS)*	PR44B	3	RLM0_GPLL_C_IN_A**/RDQ48	C (LVDS)*	
U25	PR30A	3	RLM0_GPLL_T_IN_A**/RDQ34	T (LVDS)*	PR44A	3	RLM0_GPLL_T_IN_A**/RDQ48	T (LVDS)*	
R20	RLM0_PLLCAP	3			RLM0_PLLCAP	3			
P18	VCC	3			VCCPLL	3			
T19	PR28B	3	RLM0_GDLLC_FB_A/RDQ25	C	PR42B	3	RLM0_GDLLC_FB_A/RDQ39	C	
U20	PR28A	3	RLM0_GDLLT_FB_A/RDQ25	T	PR42A	3	RLM0_GDLLT_FB_A/RDQ39	T	
GND	GNDIO3	-			GNDIO3	-			
T25	PR27B	3	RLM0_GDLLC_IN_A**/RDQ25	C (LVDS)*	PR41B	3	RLM0_GDLLC_IN_A**/RDQ39	C (LVDS)*	
T26	PR27A	3	RLM0_GDLLT_IN_A**/RDQ25	T (LVDS)*	PR41A	3	RLM0_GDLLT_IN_A**/RDQ39	T (LVDS)*	
T20	PR26B	3	RDQ25	C	PR40B	3	RDQ39	C	
T22	PR26A	3	RDQ25	T	PR40A	3	RDQ39	T	
VCCIO	VCCIO3	3			VCCIO3	3			
R26	PR25B	3	RDQ25	C (LVDS)*	PR39B	3	RDQ39	C (LVDS)*	
R25	PR25A	3	RDQS25***	T (LVDS)*	PR39A	3	RDQS39***	T (LVDS)*	
R22	NC	-			PR38B	3	RDQ39	C	
GND	GNDIO3	-			GNDIO3	-			
T21	NC	-			PR38A	3	RDQ39	T	
P26	NC	-			NC	-			
P25	NC	-			NC	-			
R24	NC	-			NC	-			
VCCIO	VCCIO3	3			VCCIO3	3			
R23	NC	-			NC	-			
P20	NC	-			NC	-			
R19	NC	-			NC	-			
P21	NC	-			PR34B	3	RDQ31	C	
GND	GNDIO3	-			GNDIO3	-			
P19	NC	-			PR34A	3	RDQ31	T	
P23	NC	-			PR33B	3	RDQ31	C (LVDS)*	
P22	NC	-			PR33A	3	RDQ31	T (LVDS)*	
N22	NC	-			PR32B	3	RDQ31	C	
VCCIO	VCCIO3	3			VCCIO3	3			
R21	NC	-			PR32A	3	RDQ31	T	
N26	NC	-			PR31B	3	RDQ31	C (LVDS)*	
N25	NC	-			PR31A	3	RDQS31	T (LVDS)*	
GND	GNDIO3	-			GNDIO3	-			
N19	PR24B	3	RDQ25	C	PR30B	3	RDQ31	C	
N20	PR24A	3	RDQ25	T	PR30A	3	RDQ31	T	
M26	PR23B	3	RDQ25	C (LVDS)*	PR29B	3	RDQ31	C (LVDS)*	
M25	PR23A	3	RDQ25	T (LVDS)*	PR29A	3	RDQ31	T (LVDS)*	
VCCIO	VCCIO3	3			VCCIO3	3			
N18	PR22B	3	VREF2_3/RDQ25	C	PR28B	3	VREF2_3/RDQ31	C	
N21	PR22A	3	VREF1_3/RDQ25	T	PR28A	3	VREF1_3/RDQ31	T	
L26	PR21B	3	PCLKC3_0/RDQ25	C (LVDS)*	PR27B	3	PCLKC3_0/RDQ31	C (LVDS)*	
L25	PR21A	3	PCLKT3_0/RDQ25	T (LVDS)*	PR27A	3	PCLKT3_0/RDQ31	T (LVDS)*	
N24	PR19B	2	PCLKC2_0/RDQ16	C	PR25B	2	PCLKC2_0/RDQ22	C	
M23	PR19A	2	PCLKT2_0/RDQ16	T	PR25A	2	PCLKT2_0/RDQ22	T	

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GND	GNDIO1	-			GNDIO1	-		
C15	PT54B	1		C	PT63B	1		C
A15	PT54A	1		T	PT63A	1		T
A13	PT53B	1		C	PT62B	1		C
B13	PT53A	1		T	PT62A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
H17	PT52B	1		C	PT61B	1		C
H15	PT52A	1		T	PT61A	1		T
D13	PT51B	1		C	PT60B	1		C
C14	PT51A	1		T	PT60A	1		T
GND	GNDIO1	-			GNDIO1	-		
G14	PT50B	1		C	PT59B	1		C
E14	PT50A	1		T	PT59A	1		T
A12	PT49B	1		C	PT58B	1		C
B12	PT49A	1		T	PT58A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
F14	PT48B	1	PCLKC1_0	C	PT57B	1	PCLKC1_0	C
D14	PT48A	1	PCLKT1_0	T	PT57A	1	PCLKT1_0	T
H16	XRES	1			XRES	1		
H14	PT46B	0	PCLKC0_0	C	PT55B	0	PCLKC0_0	C
GND	GNDIO0	-			GNDIO0	-		
H13	PT46A	0	PCLKT0_0	T	PT55A	0	PCLKT0_0	T
A11	PT45B	0		C	PT54B	0		C
B11	PT45A	0		T	PT54A	0		T
C13	PT44B	0		C	PT53B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
E13	PT44A	0		T	PT53A	0		T
D12	PT43B	0		C	PT52B	0		C
F13	PT43A	0		T	PT52A	0		T
A10	PT42B	0		C	PT51B	0		C
B10	PT42A	0		T	PT51A	0		T
C12	PT41B	0		C	PT50B	0		C
GND	GNDIO0	-			GNDIO0	-		
C10	PT41A	0		T	PT50A	0		T
G13	PT40B	0		C	PT49B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
H12	PT40A	0		T	PT49A	0		T
A9	PT39B	0		C	PT48B	0		C
B9	PT39A	0		T	PT48A	0		T
E12	PT38B	0		C	PT47B	0		C
G12	PT38A	0		T	PT47A	0		T
A8	PT37B	0		C	PT46B	0		C
B8	PT37A	0		T	PT46A	0		T
GND	GNDIO0	-			GNDIO0	-		
E11	PT36B	0		C	PT45B	0		C
C9	PT36A	0		T	PT45A	0		T

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
P3	PL54B	7	LDQ54	C (LVDS)*
R6	PL55A	7	LDQ54	T
VCCIO	VCCIO7	7		
R8	PL55B	7	LDQ54	C
P2	PL56A	7	LDQ54	T (LVDS)*
P1	PL56B	7	LDQ54	C (LVDS)*
R5	PL57A	7	PCLKT7_0/LDQ54	T
GND	GNDIO7	-		
R7	PL57B	7	PCLKC7_0/LDQ54	C
R4	PL59A	6	PCLKT6_0/LDQ63	T (LVDS)*
R3	PL59B	6	PCLKC6_0/LDQ63	C (LVDS)*
T5	PL60A	6	VREF2_6/LDQ63	T
T7	PL60B	6	VREF1_6/LDQ63	C
T3	PL61A	6	LDQ63	T (LVDS)*
VCCIO	VCCIO6	6		
T4	PL61B	6	LDQ63	C (LVDS)*
T6	PL62A	6	LDQ63	T
T8	PL62B	6	LDQ63	C
T2	PL63A	6	LDQS63	T (LVDS)*
GND	GNDIO6	-		
T1	PL63B	6	LDQ63	C (LVDS)*
U7	PL64A	6	LDQ63	T
U5	PL64B	6	LDQ63	C
VCCIO	VCCIO6	6		
U4	PL65A	6	LDQ63	T (LVDS)*
U3	PL65B	6	LDQ63	C (LVDS)*
U8	PL66A	6	LDQ63	T
U6	PL66B	6	LDQ63	C
GND	GNDIO6	-		
U2	PL67A	6	LDQ71	T (LVDS)*
U1	PL67B	6	LDQ71	C (LVDS)*
V7	PL68A	6	LDQ71	T
V5	PL68B	6	LDQ71	C
VCCIO	VCCIO6	6		
V2	PL69A	6	LDQ71	T (LVDS)*
V1	PL69B	6	LDQ71	C (LVDS)*
V8	PL70A	6	LDQ71	T
V6	PL70B	6	LDQ71	C
GND	GNDIO6	-		
W1	PL71A	6	LDQS71	T (LVDS)*
W2	PL71B	6	LDQ71	C (LVDS)*
W5	PL72A	6	LDQ71	T
VCCIO	VCCIO6	6		

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
G12	PT40B	0		C
E12	PT40A	0		T
VCCIO	VCCIO0	0		
B13	PT39B	0		C
A13	PT39A	0		T
H12	PT38B	0		C
F12	PT38A	0		T
C12	PT37B	0		C
GND	GNDIO0	-		
D12	PT37A	0		T
B12	PT36B	0		C
A12	PT36A	0		T
E11	PT35B	0		C
VCCIO	VCCIO0	0		
G11	PT35A	0		T
F11	PT34B	0		C
H11	PT34A	0		T
C11	PT33B	0		C
D11	PT33A	0		T
B11	PT32B	0		C
GND	GNDIO0	-		
A11	PT32A	0		T
E10	PT31B	0		C
VCCIO	VCCIO0	0		
G10	PT31A	0		T
F10	PT30B	0		C
H10	PT30A	0		T
D10	PT29B	0		C
C10	PT29A	0		T
GND	GNDIO0	-		
VCCIO	VCCIO0	0		
A7	PT16B	0		C
B7	PT16A	0		T
A6	PT15B	0		C
B6	PT15A	0		T
C7	PT14B	0		C
GND	GNDIO0	-		
D7	PT14A	0		T
D8	PT13B	0		C
VCCIO	VCCIO0	0		
E7	PT13A	0		T
C6	PT12B	0		C
D6	PT12A	0		T

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
G19	GND	-			GND	-			
G4	GND	-			GND	-			
H10	GND	-			GND	-			
H13	GND	-			GND	-			
J14	GND	-			GND	-			
J9	GND	-			GND	-			
K10	GND	-			GND	-			
K11	GND	-			GND	-			
K12	GND	-			GND	-			
K13	GND	-			GND	-			
K15	GND	-			GND	-			
K20	GND	-			GND	-			
K3	GND	-			GND	-			
K8	GND	-			GND	-			
L10	GND	-			GND	-			
L11	GND	-			GND	-			
L12	GND	-			GND	-			
L13	GND	-			GND	-			
M10	GND	-			GND	-			
M11	GND	-			GND	-			
M12	GND	-			GND	-			
M13	GND	-			GND	-			
N10	GND	-			GND	-			
N11	GND	-			GND	-			
N12	GND	-			GND	-			
N13	GND	-			GND	-			
N15	GND	-			GND	-			
N20	GND	-			GND	-			
N3	GND	-			GND	-			
N8	GND	-			GND	-			
P14	GND	-			GND	-			
P9	GND	-			GND	-			
R10	GND	-			GND	-			
R13	GND	-			GND	-			
T19	GND	-			GND	-			
T4	GND	-			GND	-			
W16	GND	-			GND	-			
W2	GND	-			GND	-			
W21	GND	-			GND	-			
W7	GND	-			GND	-			
Y10	GND	-			GND	-			
Y13	GND	-			GND	-			
D15	NC	-			NC	-			
G14	NC	-			NC	-			
G15	NC	-			NC	-			
D14	NC	-			NC	-			
E15	NC	-			NC	-			
E14	NC	-			NC	-			

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
C12	URC_SQ_VCCIB2	12		
B12	URC_SQ_HDINN2	12		C
C11	URC_SQ_VCCR2	12		
A15	URC_SQ_HDOUTP2	12		T
C15	URC_SQ_VCCOB2	12		
B15	URC_SQ_HDOUTN2	12		C
C14	URC_SQ_VCCTX2	12		
B14	URC_SQ_HDOUTN3	12		C
A13	URC_SQ_VCCOB3	12		
A14	URC_SQ_HDOUTP3	12		T
C13	URC_SQ_VCCTX3	12		
B11	URC_SQ_HDINN3	12		C
B10	URC_SQ_VCCIB3	12		
A11	URC_SQ_HDINP3	12		T
C10	URC_SQ_VCCR3	12		
GNDIO	GNDIO1	-		
VCCIO	VCCIO1	1		
E13	PT55B	1		C
D12	PT55A	1		T
GNDIO	GNDIO1	-		
A9	PT54B	1		C
A8	PT54A	1		T
A7	PT53B	1		C
A6	PT53A	1		T
VCCIO	VCCIO1	1		
E12	PT52B	1		C
F12	PT52A	1		T
A5	PT51B	1		C
A4	PT51A	1		T
GNDIO	GNDIO1	-		
B7	PT50B	1		C
B8	PT50A	1		T
G11	PT49B	1		C
E11	PT49A	1		T
VCCIO	VCCIO1	1		
D11	PT48B	1	VREF2_1	C
D10	PT48A	1	VREF1_1	T
G10	PT47B	1	PCLKC1_0	C
F11	PT47A	1	PCLKT1_0	T
G9	PT46B	0	PCLKC0_0	C
GNDIO	GNDIO0	-		
F9	PT46A	0	PCLKT0_0	T
C9	PT45B	0	VREF2_0	C

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
L11	GND	-		
L12	GND	-		
L13	GND	-		
M10	GND	-		
M11	GND	-		
M12	GND	-		
M13	GND	-		
N10	GND	-		
N11	GND	-		
N12	GND	-		
N13	GND	-		
N15	GND	-		
N20	GND	-		
N3	GND	-		
N8	GND	-		
P14	GND	-		
P9	GND	-		
R10	GND	-		
R13	GND	-		
T19	GND	-		
T4	GND	-		
W16	GND	-		
W2	GND	-		
W21	GND	-		
W7	GND	-		
Y10	GND	-		
Y13	GND	-		
Y15	NC	-		
W15	NC	-		
AB20	NC	-		
AB21	NC	-		
AA21	NC	-		
AA20	NC	-		
AB19	NC	-		
AB18	NC	-		
Y22	NC	-		
Y21	NC	-		
Y17	NC	-		
Y18	NC	-		
Y16	NC	-		
W17	NC	-		
Y19	NC	-		
Y20	NC	-		

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
GNDIO	GNDIO7	-			GNDIO7	-			
K5	PL23A	7	LDQS23	T (LVDS)*	PL27A	7	LDQS27	T*	
L5	PL23B	7	LDQ23	C (LVDS)*	PL27B	7	LDQ27	C*	
K4	PL24A	7	LDQ23	T	PL28A	7	LDQ27	T	
VCCIO	VCCIO7	7			VCCIO7	7			
L4	PL24B	7	LDQ23	C	PL28B	7	LDQ27	C	
K3	PL25A	7	LDQ23	T (LVDS)*	PL29A	7	LDQ27	T*	
L3	PL25B	7	LDQ23	C (LVDS)*	PL29B	7	LDQ27	C*	
J1	PL26A	7	LDQ23	T	PL30A	7	LDQ27	T	
GNDIO	GNDIO7	-			GNDIO7	-			
K2	PL26B	7	LDQ23	C	PL30B	7	LDQ27	C	
K1	PL28A	7	LUM1_SPLLT_IN_A/LDQ32	T (LVDS)*	PL32A	7	LUM3_SPLLT_IN_A/LDQ36	T*	
L1	PL28B	7	LUM1_SPLLC_IN_A/LDQ32	C (LVDS)*	PL32B	7	LUM3_SPLLC_IN_A/LDQ36	C*	
K8	PL29A	7	LUM1_SPLLT_FB_A/LDQ32	T	PL33A	7	LUM3_SPLLT_FB_A/LDQ36	T	
M5	PL29B	7	LUM1_SPLLC_FB_A/LDQ32	C	PL33B	7	LUM3_SPLLC_FB_A/LDQ36	C	
VCCIO	VCCIO7	7			VCCIO7	7			
M4	PL30A	7	LDQ32	T (LVDS)*	PL34A	7	LDQ36	T*	
M3	PL30B	7	LDQ32	C (LVDS)*	PL34B	7	LDQ36	C*	
L8	PL31A	7	LDQ32	T	PL35A	7	LDQ36	T	
M6	PL31B	7	LDQ32	C	PL35B	7	LDQ36	C	
GNDIO	GNDIO7	-			GNDIO7	-			
M1	PL32A	7	LDQS32	T (LVDS)*	PL36A	7	LDQS36	T*	
N1	PL32B	7	LDQ32	C (LVDS)*	PL36B	7	LDQ36	C*	
N3	PL33A	7	LDQ32	T	PL37A	7	LDQ36	T	
VCCIO	VCCIO7	7			VCCIO7	7			
N2	PL33B	7	LDQ32	C	PL37B	7	LDQ36	C	
N5	PL34A	7	LDQ32	T (LVDS)*	PL38A	7	LDQ36	T*	
N4	PL34B	7	LDQ32	C (LVDS)*	PL38B	7	LDQ36	C*	
M7	PL35A	7	PCLKT7_0/LDQ32	T	PL39A	7	PCLKT7_0/LDQ36	T	
GNDIO	GNDIO7	-			GNDIO7	-			
M8	PL35B	7	PCLKC7_0/LDQ32	C	PL39B	7	PCLKC7_0/LDQ36	C	
P3	PL37A	6	PCLKT6_0	T (LVDS)*	PL41A	6	PCLKT6_0	T*	
P2	PL37B	6	PCLKC6_0	C (LVDS)*	PL41B	6	PCLKC6_0	C*	
P5	PL38A	6	VREF2_6	T	PL42A	6	VREF2_6	T	
N6	PL38B	6	VREF1_6	C	PL42B	6	VREF1_6	C	
P4	PL39A	6		T (LVDS)*	PL43A	6		T*	
VCCIO	VCCIO6	6			VCCIO6	6			
R3	PL39B	6		C (LVDS)*	PL43B	6		C*	
P6	PL40A	6		T	PL44A	6		T	
N7	NC	-			PL44B	6		C	
P1	PL41A	6	LLM2_SPLLT_IN_A	T (LVDS)*	PL45A	6	LLM3_SPLLT_IN_A	T*	
GNDIO	GNDIO6	-			GNDIO6	-			
R1	PL41B	6	LLM2_SPLLC_IN_A	C (LVDS)*	PL45B	6	LLM3_SPLLC_IN_A	C*	
N8	PL42A	6	LLM2_SPLLT_FB_A	T	PL46A	6	LLM3_SPLLT_FB_A	T	
R5	PL42B	6	LLM2_SPLLC_FB_A	C	PL46B	6	LLM3_SPLLC_FB_A	C	
VCCIO	VCCIO6	6			VCCIO6	6			
T3	PL44A	6	LDQ48	T (LVDS)*	PL48A	6	LDQ52	T*	
T4	PL44B	6	LDQ48	C (LVDS)*	PL48B	6	LDQ52	C*	

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
T29	PR48B	3	RDQ52	C (LVDS)*	PR60B	3	RDQ64	C (LVDS)*	
T28	PR48A	3	RDQ52	T (LVDS)*	PR60A	3	RDQ64	T (LVDS)*	
R23	PR46B	3	RLM3_SPLLC_FB_A	C	PR58B	3	RLM3_SPLLC_FB_A/RDQ55	C	
GNDIO	GNDIO3	-			GNDIO3	-			
VCCIO	VCCIO3	3			-	-			
R22	PR46A	3	RLM3_SPLLT_FB_A	T	PR58A	3	RLM3_SPLLT_FB_A/RDQ55	T	
P30	PR45B	3	RLM3_SPLLC_IN_A	C (LVDS)*	PR57B	3	RLM3_SPLLC_IN_A/RDQ55	C (LVDS)*	
R29	PR45A	3	RLM3_SPLLT_IN_A	T (LVDS)*	PR57A	3	RLM3_SPLLT_IN_A/RDQ55	T (LVDS)*	
T27	PR44B	3		C	PR56B	3	RDQ55	C	
-	-	-			VCCIO3	3			
T26	PR44A	3		T	PR56A	3	RDQ55	T	
GNDIO	GNDIO3	-			GNDIO3	-			
N30	PR43B	3		C (LVDS)*	PR53B	3	RDQ55	C (LVDS)*	
N29	PR43A	3		T (LVDS)*	PR53A	3	RDQ55	T (LVDS)*	
VCCIO	VCCIO3	3			VCCIO3	3			
R27	PR42B	3	VREF2_3	C	PR52B	3	VREF2_3/RDQ55	C	
R28	PR42A	3	VREF1_3	T	PR52A	3	VREF1_3/RDQ55	T	
P29	PR41B	3	PCLKC3_0	C (LVDS)*	PR51B	3	PCLKC3_0/RDQ55	C (LVDS)*	
P28	PR41A	3	PCLKT3_0	T (LVDS)*	PR51A	3	PCLKT3_0/RDQ55	T (LVDS)*	
M30	PR39B	2	PCLKC2_0/RDQ36	C	PR49B	2	PCLKC2_0/RDQ46	C	
M29	PR39A	2	PCLKT2_0/RDQ36	T	PR49A	2	PCLKT2_0/RDQ46	T	
GNDIO	GNDIO2	-			GNDIO2	-			
P23	PR38B	2	RDQ36	C (LVDS)*	PR48B	2	RDQ46	C (LVDS)*	
P24	PR38A	2	RDQ36	T (LVDS)*	PR48A	2	RDQ46	T (LVDS)*	
R26	PR37B	2	RDQ36	C	PR47B	2	RDQ46	C	
P27	PR37A	2	RDQ36	T	PR47A	2	RDQ46	T	
VCCIO	VCCIO2	2			VCCIO2	2			
P25	PR36B	2	RDQ36	C (LVDS)*	PR46B	2	RDQ46	C (LVDS)*	
P26	PR36A	2	RDQS36	T (LVDS)*	PR46A	2	RDQS46	T (LVDS)*	
K30	PR35B	2	RDQ36	C	PR45B	2	RDQ46	C	
GNDIO	GNDIO2	-			GNDIO2	-			
K29	PR35A	2	RDQ36	T	PR45A	2	RDQ46	T	
N22	PR34B	2	RDQ36	C (LVDS)*	PR44B	2	RDQ46	C (LVDS)*	
P22	PR34A	2	RDQ36	T (LVDS)*	PR44A	2	RDQ46	T (LVDS)*	
J30	PR33B	2	RUM3_SPLLC_FB_A/RDQ36	C	PR43B	2	RUM3_SPLLC_FB_A/RDQ46	C	
VCCIO	VCCIO2	2			VCCIO2	2			
J29	PR33A	2	RUM3_SPLLT_FB_A/RDQ36	T	PR43A	2	RUM3_SPLLT_FB_A/RDQ46	T	
N24	PR32B	2	RUM3_SPLLC_IN_A/RDQ36	C (LVDS)*	PR42B	2	RUM3_SPLLC_IN_A/RDQ46	C (LVDS)*	
N23	PR32A	2	RUM3_SPLLT_IN_A/RDQ36	T (LVDS)*	PR42A	2	RUM3_SPLLT_IN_A/RDQ46	T (LVDS)*	
N25	PR30B	2	RDQ27	C	PR40B	2	RDQ37	C	
N26	PR30A	2	RDQ27	T	PR40A	2	RDQ37	T	
GNDIO	GNDIO2	-			GNDIO2	-			
M27	PR29B	2	RDQ27	C (LVDS)*	PR39B	2	RDQ37	C (LVDS)*	
M28	PR29A	2	RDQ27	T (LVDS)*	PR39A	2	RDQ37	T (LVDS)*	
H30	PR28B	2	RDQ27	C	PR38B	2	RDQ37	C	
G30	PR28A	2	RDQ27	T	PR38A	2	RDQ37	T	
VCCIO	VCCIO2	2			VCCIO2	2			
M25	PR27B	2	RDQ27	C (LVDS)*	PR37B	2	RDQ37	C (LVDS)*	

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
U7	PL60A	6	VREF2_6/LDQ63	T
T8	PL60B	6	VREF1_6/LDQ63	C
R3	PL61A	6	LDQ63	T (LVDS)*
VCCIO	VCCIO6	6		
R2	PL61B	6	LDQ63	C (LVDS)*
R1	PL62A	6	LDQ63	T
T1	PL62B	6	LDQ63	C
GNDIO	GNDIO6	-		
VCCIO	VCCIO6	6		
T3	PL65A	6	LLM4_SPLLT_IN_A/LDQ63	T (LVDS)*
T2	PL65B	6	LLM4_SPLLC_IN_A/LDQ63	C (LVDS)*
U9	PL66A	6	LLM4_SPLLT_FB_A/LDQ63	T
U8	PL66B	6	LLM4_SPLLC_FB_A/LDQ63	C
GNDIO	GNDIO6	-		
U5	PL68A	6	LDQ72	T (LVDS)*
U4	PL68B	6	LDQ72	C (LVDS)*
V9	PL69A	6	LDQ72	T
V7	PL69B	6	LDQ72	C
VCCIO	VCCIO6	6		
U3	PL70A	6	LDQ72	T (LVDS)*
U2	PL70B	6	LDQ72	C (LVDS)*
V8	PL71A	6	LDQ72	T
U6	PL71B	6	LDQ72	C
GNDIO	GNDIO6	-		
U1	PL72A	6	LDQS72	T (LVDS)*
V2	PL72B	6	LDQ72	C (LVDS)*
V5	PL73A	6	LDQ72	T
VCCIO	VCCIO6	6		
V6	PL73B	6	LDQ72	C
V1	PL74A	6	LDQ72	T (LVDS)*
W1	PL74B	6	LDQ72	C (LVDS)*
W5	PL75A	6	LDQ72	T
GNDIO	GNDIO6	-		
W6	PL75B	6	LDQ72	C
W3	PL77A	6	LDQ81	T (LVDS)*
W4	PL77B	6	LDQ81	C (LVDS)*
W2	PL78A	6	LDQ81	T
Y4	PL78B	6	LDQ81	C
Y1	PL79A	6	LDQ81	T (LVDS)*
VCCIO	VCCIO6	6		
Y2	PL79B	6	LDQ81	C (LVDS)*
Y5	PL80A	6	LDQ81	T
Y6	PL80B	6	LDQ81	C

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
M10	VCCIO7	7		
M7	VCCIO7	7		
N10	VCCIO7	7		
N3	VCCIO7	7		
P10	VCCIO7	7		
R6	VCCIO7	7		
AA25	VCCIO8	8		
AD28	VCCIO8	8		
AA10	VCCAUX	-		
AA11	VCCAUX	-		
AA20	VCCAUX	-		
AA21	VCCAUX	-		
K10	VCCAUX	-		
K11	VCCAUX	-		
K20	VCCAUX	-		
K21	VCCAUX	-		
L10	VCCAUX	-		
L11	VCCAUX	-		
L20	VCCAUX	-		
L21	VCCAUX	-		
Y10	VCCAUX	-		
Y11	VCCAUX	-		
Y20	VCCAUX	-		
Y21	VCCAUX	-		
A1	GND	-		
A13	GND	-		
A18	GND	-		
A24	GND	-		
A30	GND	-		
A7	GND	-		
AA14	GND	-		
AA15	GND	-		
AA16	GND	-		
AA17	GND	-		
AA24	GND	-		
AA27	GND	-		
AA4	GND	-		
AB24	GND	-		
AB7	GND	-		
AD12	GND	-		
AD19	GND	-		
AD27	GND	-		
AE22	GND	-		

LatticeECP2M Standard Series Devices, Conventional Packaging
Commercial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M20E-5F484C	304	1.2V	-5	fpBGA	484	COM	20
LFE2M20E-6F484C	304	1.2V	-6	fpBGA	484	COM	20
LFE2M20E-7F484C	304	1.2V	-7	fpBGA	484	COM	20
LFE2M20E-5F256C	140	1.2V	-5	fpBGA	256	COM	20
LFE2M20E-6F256C	140	1.2V	-6	fpBGA	256	COM	20
LFE2M20E-7F256C	140	1.2V	-7	fpBGA	256	COM	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M35E-5F672C	410	1.2V	-5	fpBGA	672	COM	35
LFE2M35E-6F672C	410	1.2V	-6	fpBGA	672	COM	35
LFE2M35E-7F672C	410	1.2V	-7	fpBGA	672	COM	35
LFE2M35E-5F484C	303	1.2V	-5	fpBGA	484	COM	35
LFE2M35E-6F484C	303	1.2V	-6	fpBGA	484	COM	35
LFE2M35E-7F484C	303	1.2V	-7	fpBGA	484	COM	35
LFE2M35E-5F256C	140	1.2V	-5	fpBGA	256	COM	35
LFE2M35E-6F256C	140	1.2V	-6	fpBGA	256	COM	35
LFE2M35E-7F256C	140	1.2V	-7	fpBGA	256	COM	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M50E-5F900C	410	1.2V	-5	fpBGA	900	COM	50
LFE2M50E-6F900C	410	1.2V	-6	fpBGA	900	COM	50
LFE2M50E-7F900C	410	1.2V	-7	fpBGA	900	COM	50
LFE2M50E-5F672C	372	1.2V	-5	fpBGA	672	COM	50
LFE2M50E-6F672C	372	1.2V	-6	fpBGA	672	COM	50
LFE2M50E-7F672C	372	1.2V	-7	fpBGA	672	COM	50
LFE2M50E-5F484C	270	1.2V	-5	fpBGA	484	COM	50
LFE2M50E-6F484C	270	1.2V	-6	fpBGA	484	COM	50
LFE2M50E-7F484C	270	1.2V	-7	fpBGA	484	COM	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M70E-5F1152C	436	1.2V	-5	fpBGA	1152	COM	70
LFE2M70E-6F1152C	436	1.2V	-6	fpBGA	1152	COM	70
LFE2M70E-7F1152C	436	1.2V	-7	fpBGA	1152	COM	70
LFE2M70E-5F900C	416	1.2V	-5	fpBGA	900	COM	70
LFE2M70E-6F900C	416	1.2V	-6	fpBGA	900	COM	70
LFE2M70E-7F900C	416	1.2V	-7	fpBGA	900	COM	70

Date	Version	Section	Change Summary
November 2009 (cont.)	03.5 (cont.)	Pinout Information (cont.)	LatticeECP2M Pin Information Summary, LFE2M50, LFE2M70 and LFE2M100 table - corrected values for LFE2M50, 672 fpBGA in Available DDR-Interfaces per I/O Bank.
			Minor corrections in LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA table.
			Minor corrections in LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA table.
			Minor corrections in LFE2M100E/SE Logic Signal Connections: 900 fpBGA table.
			Updated LFE2-6E/SE and LFE2-12E/SE Logical Signal Connections (changed D1/SPIDS to D1).
		Ordering Information	Updated LatticeECP2M Part Number Description diagram.
March 2010	03.6	DC and Switching Characteristics	Footnote for SED operating frequency added to the sysCONFIG Port Timing Specifications table.
		Pinout Information	Changed Dual Function pin E7 to be D7/SPDI0 in Logic Signal Connections tables. Changed footnote (***) in Logic Signal Connections table.
July 2010	03.7	Architecture	Updated the Typical sysIO Behavior During Power-up text section.
		Pinout Information	Added reference to powerup information.
			Corrected reference to footnote for pins 131 and 132 for the LFE-20E/SE, 208 PQFP.
			Referenced footnote (***) for all D7/SPID0.
			Changed D7*** to D7/SPID0.
			Corrected *** footnote.
		All Sections	Included references to Lattice Diamond design software wherever ispLEVER and ispLeverCORE is specified.
April 2011	03.8	DC and Switching Characteristics	DC Electrical Characteristics table: - Added footnote 3 to I_{IH} - Added footnote 2 to I_{IL} , I_{IH} - Updated C1 and C2 typ. and max. data.
			DLL Timing table – Removed line for t_R and t_F
			LatticeECP2/M sysCONFIG Port Timing Specifications table – added footnote to t_{DINIT} .
			Figure 3-18 – Corrected label to be PRGM (not PRGMRJ).
		Pinout Information	LFE2-12E/SE and LFE-20/SE Logical Signal Connections for 208 PQFP – Corrected Dual Function information for pins 112, 114, 117, 119.
January 2012	03.9	Multiple	Removed references to ispLEVER design software.
		Architecture	Corrected information regarding SED support.
		DC and Switching Characteristics	Added reference to ESD information.
June 2013	04.0	All	Updated document with new corporate logo.
		Architecture	Architecture Overview – Added information on the state of the register on power up and after configuration.